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Orderable:	Designed for: Public Release	Mod. Date: 12/18/2015
TID #: TIDA-00456	Project Title: On-board Charger Load Feedback Sub-system	
Number: TIDA-00456	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	
Drawn By: A. WHITEHEAD	File: TIDA-00456A_Main.SchDoc	Sheet: 1 of 2
Engineer: Harmouch, Mahmoud	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	Size: B



PCB Number: TIDA-00456  
 PCB Rev: A

PCB  
 LOGO  
 Texas Instruments

PCB  
 LOGO  
 Pb-Free Symbol

ZZ2  
 Assembly Note  
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
 Assembly Note  
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
 Assembly Note  
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable:	Designed for: Public Release	Mod. Date: 12/18/2015	 <b>TEXAS INSTRUMENTS</b> <a href="http://www.ti.com">http://www.ti.com</a> <small>© Texas Instruments 2015</small>
TID #: TIDA-00456	Project Title: On-board Charger Load Feedback Sub-system		
Number: TIDA-00456	Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By:	File: TIDA-00456A_Hardware.SchDoc	Size: B	
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